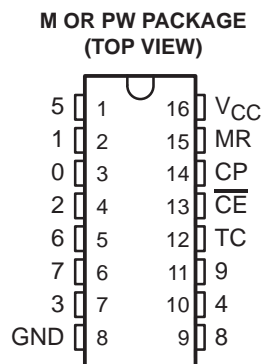


CD74HC4017-Q1

HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

- Qualification in Accordance With AEC-Q100†
 - Qualified for Automotive Applications
 - Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
 - Fully Static Operation
 - Buffered Inputs
 - Common Reset
 - Positive Edge Clocking
 - Typical $f_{MAX} = 60$ MHz at $V_{CC} = 5$ V, $C_L = 15$ pF, $T_A = 25^\circ\text{C}$
 - Fanout (Over Temperature Range)
 - Standard Outputs . . . 10 LSTTL Loads
 - Bus Driver Outputs . . . 15 LSTTL Loads
 - Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
 - V_{CC} Voltage = 2 V to 6 V
 - High Noise Immunity N_{IL} or $N_{IH} = 30\%$ of V_{CC} , $V_{CC} = 5$ V



† Contact factory for details. Q100 qualification data available on request.

description/ordering information

The CD74HC4017 is a high-speed silicon-gate CMOS 5-stage Johnson counter with ten decoded outputs. Each of the decoded outputs normally is low and sequentially goes high on the low-to-high transition clock period of the ten-clock-period cycle. The carry (TC) output transitions low to high after output 9 goes from high to low, and can be used in conjunction with the clock enable (\overline{CE}) input to cascade several stages. \overline{CE} disables counting when in the high state. A master reset (MR) input also is provided that, when taken high, sets all the decoded outputs, except output 0, to low.

The device can drive up to ten low-power Schottky equivalent loads.

ORDERING INFORMATION

T _A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	SOIC – M	Tape and reel	CD74HC4017QM96Q1	HC4017Q
	TSSOP – PW	Tape and reel	CD74HC4017QPWRQ1	HC4017Q

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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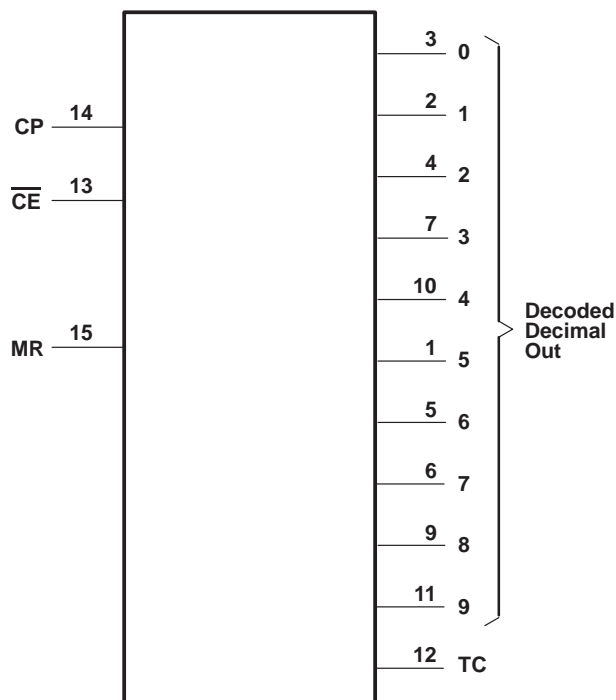
FUNCTION TABLE

INPUTS			OUTPUT STATE†
CP	\overline{CE}	MR	
L	X	L	No change
X	H	L	No change
X	X	H	0 = H, 1–9 = L
↑	L	L	Increments counter
↓	X	L	No change
X	↑	L	No change
H	↓	L	Increments counter

NOTE: H = high voltage level, L = low voltage level,
X = don't care, ↑ = transition from low to high
level, ↓ = transition from high to low level

† If $n < 5$, TC = H, otherwise TC = L

logic diagram (positive logic)



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HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER WITH 10 DECODED OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1)	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)	±20 mA
Output clamp current, I_{OK} ($V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)	±20 mA
Source or sink current per output pin, I_O ($V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): M package	73°C/W
PW package	108°C/W
Maximum junction temperature, T_J	150°C
Lead temperature (during soldering):	
At distance $1/16 \pm 1/32$ inch ($1,59 \pm 0,79$ mm) from case for 10 s max	300°C
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages referenced to GND unless otherwise specified.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT	
V_{CC}	Supply voltage	2	6	V	
V_{IH}	High-level input voltage	$V_{CC} = 2$ V	1.5	V	
		$V_{CC} = 4.5$ V	3.15		
		$V_{CC} = 6$ V	4.2		
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V	0.5	V	
		$V_{CC} = 4.5$ V	1.35		
		$V_{CC} = 6$ V	1.8		
V_I	Input voltage	0	V_{CC}	V	
V_O	Output voltage	0	V_{CC}	V	
t_t	Input transition (rise and fall) time	$V_{CC} = 2$ V	0	1000	ns
		$V_{CC} = 4.5$ V	0	500	
		$V_{CC} = 6$ V	0	400	
T_A	Operating free-air temperature	–40	125	°C	

- NOTES: 3. All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER
WITH 10 DECODED OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		I _O (mA)	V _{CC}	T _A = 25°C		MIN	MAX	UNIT
					MIN	MAX			
V _{OH}	V _I = V _{IH} or V _{IL}	CMOS loads	-0.02	2 V	1.9		1.9	V	
			-0.02	4.5 V	4.4	4.4			
			-0.02	6 V	5.9	5.9			
		TTL loads	-4	4.5 V	3.98	3.7			
			-5.2	6 V	5.48	5.2			
V _{OL}	V _I = V _{IH} or V _{IL}	CMOS loads	0.02	2 V		0.1	0.1	V	
			0.02	4.5 V		0.1	0.1		
			0.02	6 V		0.1	0.1		
		TTL loads	4	4.5 V	0.26	0.4			
			5.2	6 V	0.26	0.4			
I _I	V _I = V _{CC} or GND		6 V		±0.1		±1	µA	
I _{CC}	V _I = V _{CC} or GND		6 V		8		160	µA	
C _{IN}	C _L = 50 pF					10	10	pF	

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER			V _{CC}	T _A = 25°C		MIN	MAX	UNIT
				MIN	MAX			
f _{max}	Maximum clock frequency		2 V		6		4	MHz
			4.5 V		30		20	
			6 V		35		23	
t _w	Pulse duration	CP	2 V		80		120	ns
			4.5 V		16		24	
			6 V		14		20	
		MR	2 V		80		120	
			4.5 V		16		24	
			6 V		14		20	
t _{su}	Setup time	$\overline{\text{CE}}$ to CP	2 V		75		110	ns
			4.5 V		15		22	
			6 V		13		19	
		MR inactive	2 V		5		5	
			4.5 V		5		5	
			6 V		5		5	
t _h	Hold time, $\overline{\text{CE}}$ to CP		2 V		0		0	ns
			4.5 V		0		0	
			6 V		0		0	



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HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER WITH 10 DECODED OUTPUTS

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	V _{CC}	T _A = 25°C			MIN	MAX	UNIT
					MIN	TYP	MAX			
t _{pd}	CP	Decade out	C _L = 50 pF	2 V		230		345	ns	
				4.5 V		46		69		
				6 V		39		59		
		TC	C _L = 15 pF	5 V		19				
				C _L = 50 pF	2 V		230			345
					4.5 V		46			69
	6 V		39			59				
	MR	Decade out	C _L = 50 pF	2 V		250		375		
				4.5 V		50		75		
				6 V		43		64		
		TC	C _L = 15 pF	5 V		21				
				C _L = 50 pF	2 V		250			375
					4.5 V		50			75
	6 V		43			64				
	MR	Decade out	C _L = 50 pF	2 V		230		345		
				4.5 V		46		69		
				6 V		39		59		
		TC	C _L = 15 pF	5 V		19				
C _L = 50 pF				2 V		230		345		
				4.5 V		46		69		
	6 V		39		59					
t _t		TC, Decade out	C _L = 50 pF	2 V		75		110	ns	
				4.5 V		15		22		
				6 V		13		19		
f _{max}	CP		C _L = 15 pF	5 V		60			MHz	

operating characteristics, V_{CC} = 5 V, T_A = 25°C, input t_r, t_f = 6 ns, C_L = 15 pF

PARAMETER	TYP	UNIT
C _{pd} Power dissipation capacitance (see Note 4)	39	pF

NOTE 4: C_{pd} is used to determine the dynamic power consumption per package.

$$P_D = (C_{pd} \times V_{CC}^2 \times f_i) + \sum(C_L \times V_{CC}^2 \times f_o)$$

f_i = input frequency

f_o = output frequency

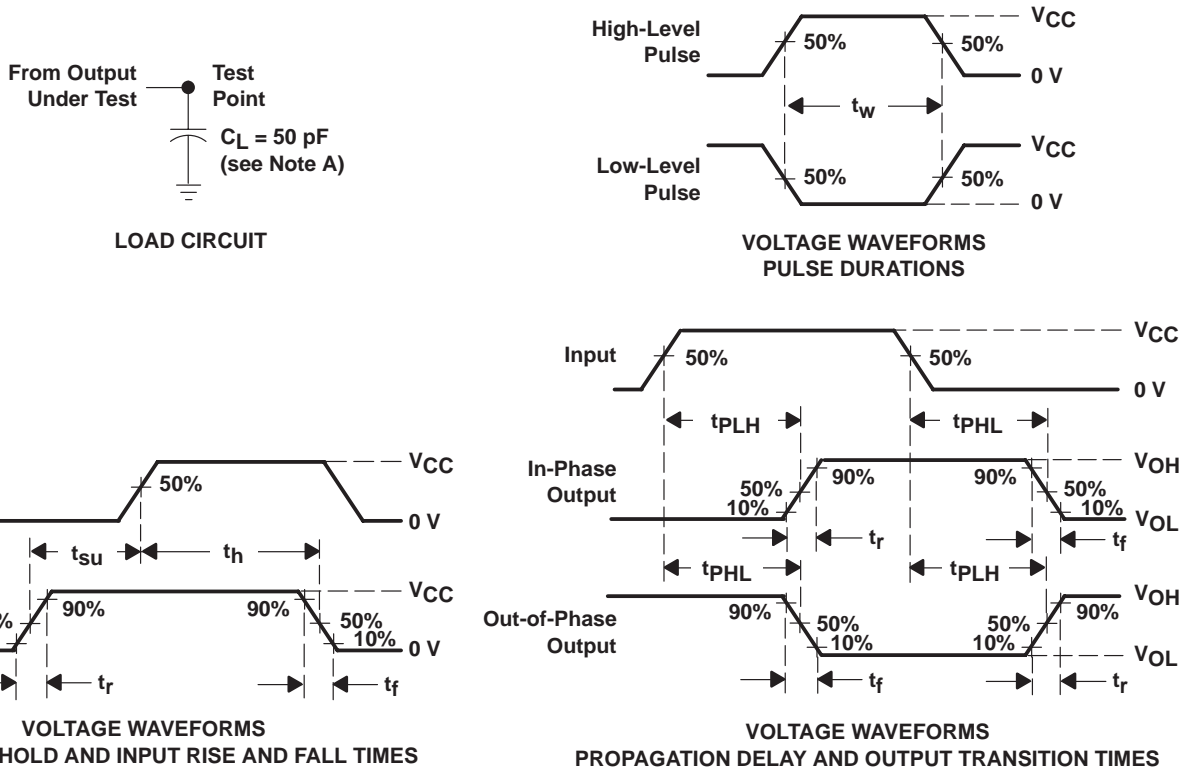
C_L = output load capacitance

V_{CC} = supply voltage

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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 - C. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{pLH} and t_{pHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

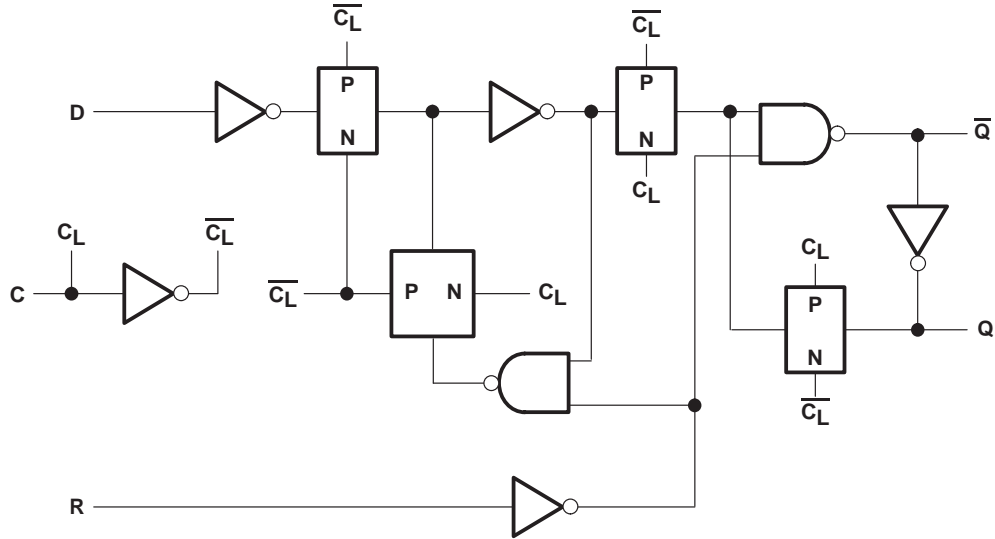


Figure 2. Flip-Flop Detail

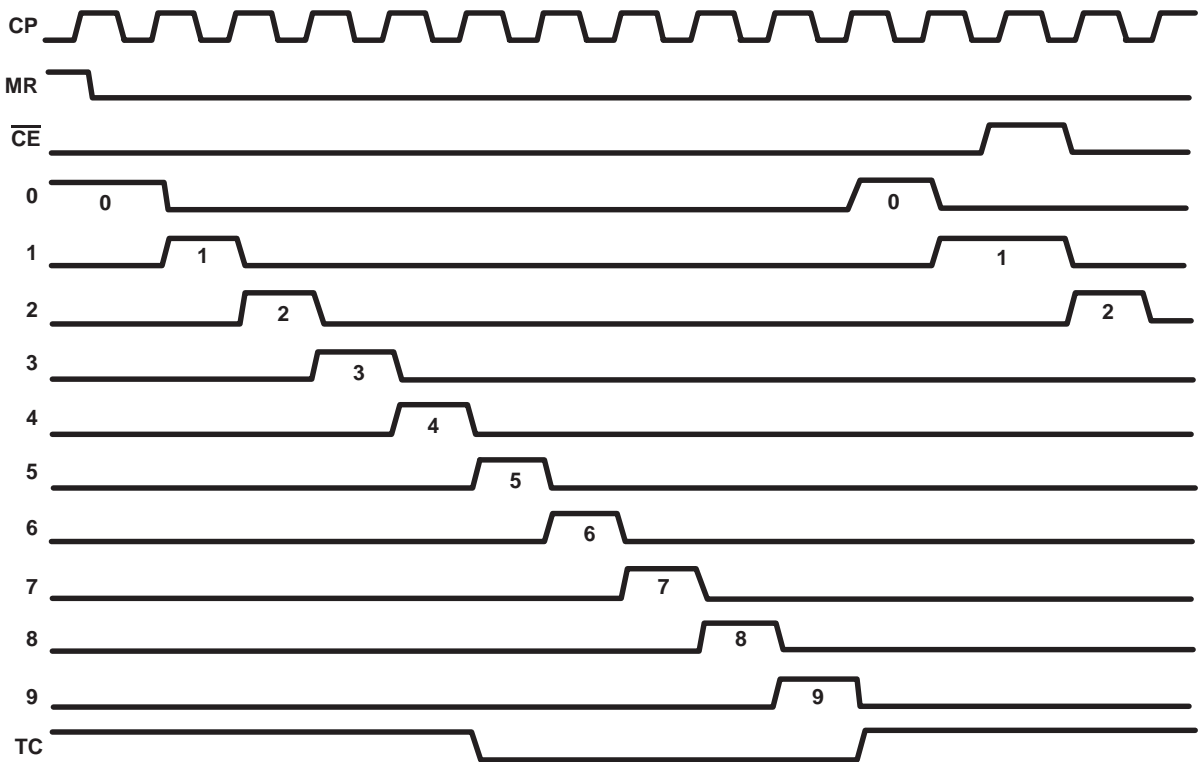


Figure 3. Timing Diagram

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AC.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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